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M16C/62P Group

Controlling Power Using Wait Mode

1. Abstract

The following are steps for controlling power using wait mode. Figure 1 shows the operation timing, and Figures 2 to 3 show the set-up procedure. A reference program is an example when using the INT0, Timer B2 interrupt based on the setting procedure of Figure 2 to Figure 4.

2. Introduction

This application note is applied to the M16C/62P group Microcomputers.

This program can be operated under the condition of M16C family products with the same SFR(Special Function Register) as M16C/62P Group products. Because some functions may be modified of the M16C family products, see the user's manual. When using the functions shown in this application note, evaluate them carefully for an operation

3. Specifications

Use the following peripheral functions:

- Timer mode of timer B
- Wait mode

A flag named “F_WIT” is used in the set-up procedure. The purpose of this flag is to decide whether or not to clear wait mode. If F_WIT=“1” in the main program, the wait mode is entered; if F_WIT=“0”, the wait mode is cleared.

- (1) Connect a 32.768-kHz oscillator to XCIN to serve as the timer count source. As interrupts occur every one second, which is a count the timer reaches, the controller returns from wait mode and count the clock a using a program. Also the RAM named “WACTH_CNT” is used in the reference program in order to count a clock.
- (2) Clear wait mode if a $\overline{\text{INT0}}$ interrupt request occurs

4. Operation

- (1) Switch the system clock from XIN to XCIN to get low-speed mode.
- (2) Stop XIN and enter wait mode. in this instance, enable the timer B2 interrupt and the $\overline{\text{INT0}}$ interrupt.
- (3) When a timer B2 interrupt request occurs (at 1-second intervals), start supplying the BCLK from XCIN. At this time, count the clock within the routine that handles the timer B2 interrupts and enter wait mode again.
- (4) If a $\overline{\text{INT0}}$ interrupt occurs, start supplying the BCLK from XCIN. Start the XIN oscillation within the $\overline{\text{INT0}}$ interrupt, and switch the system clock to XIN.

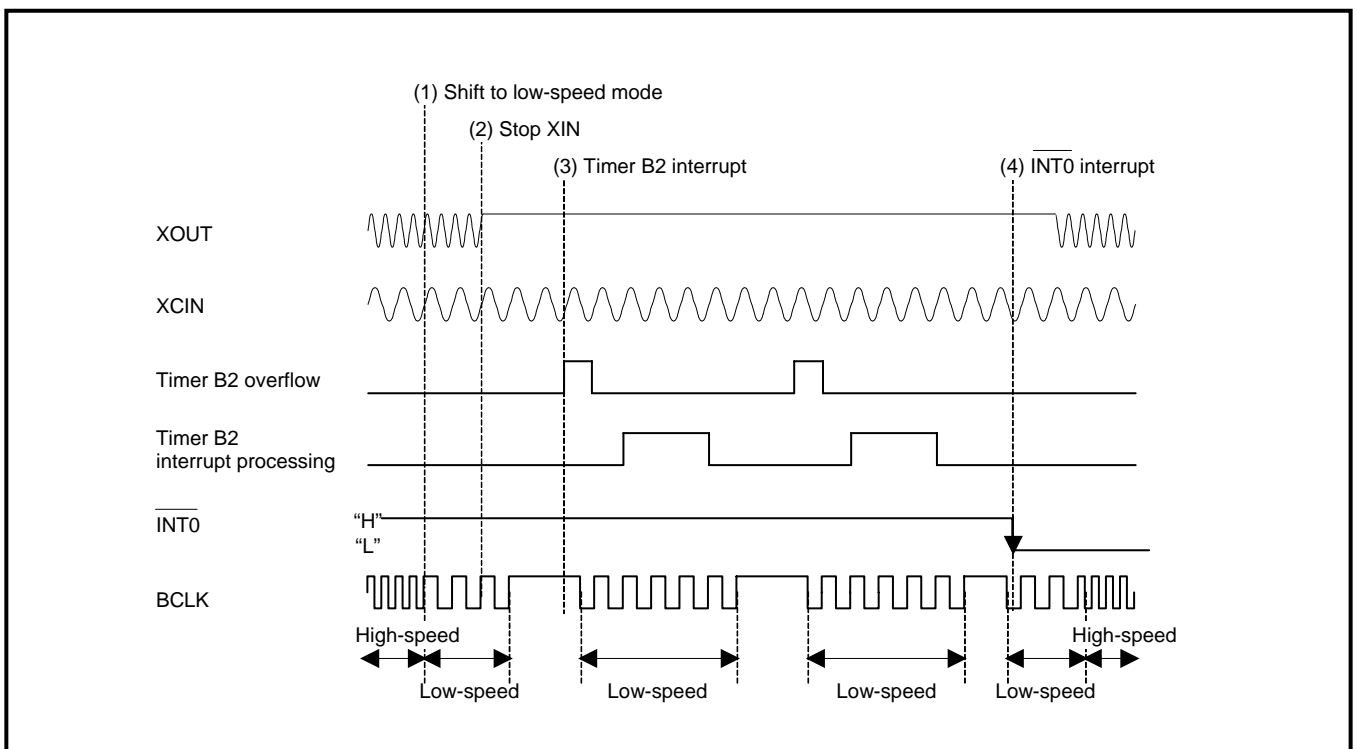


Figure 1. Operation timing of controlling power using wait mode

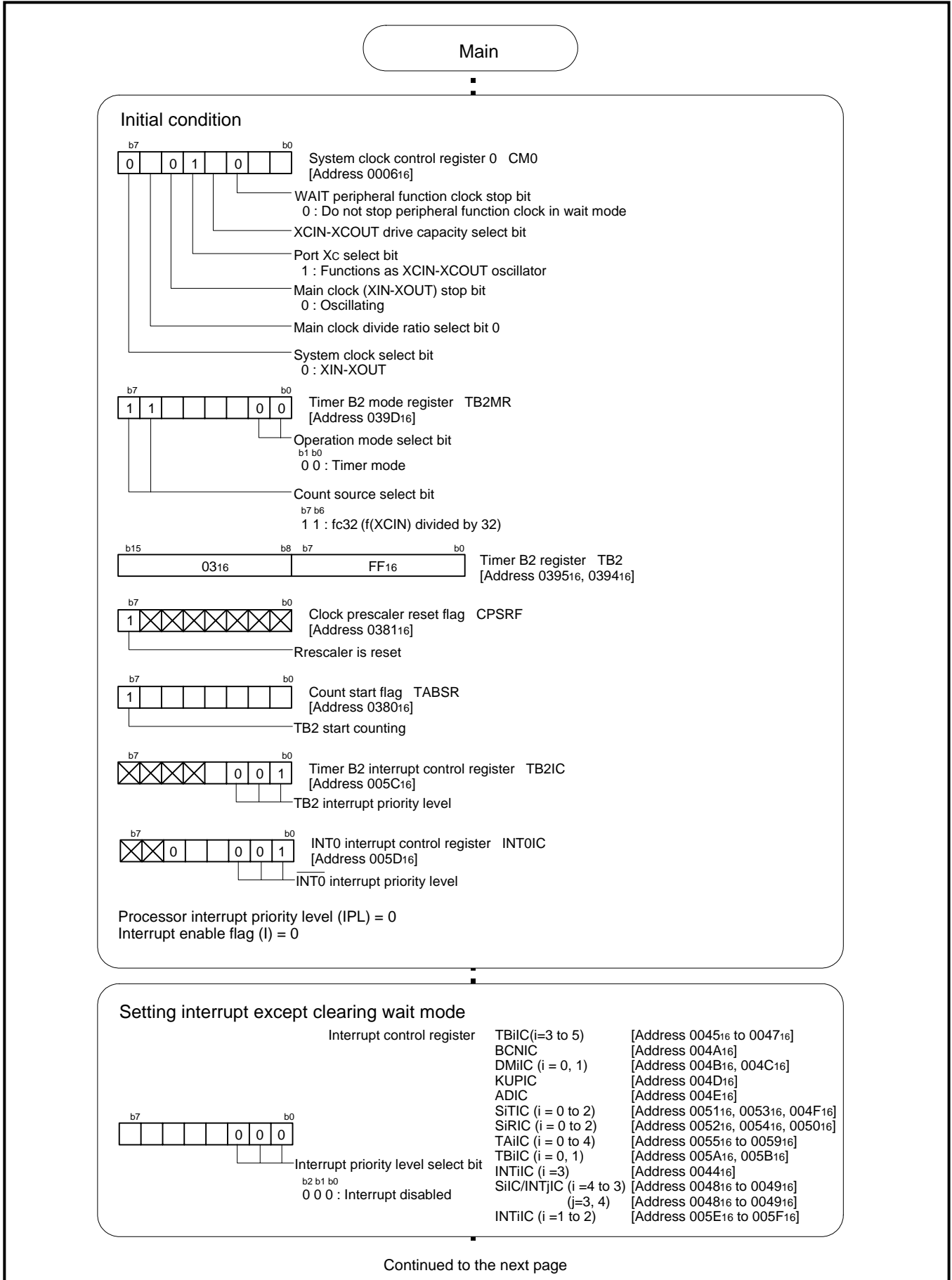


Figure 2. Set-up procedure of controlling power using wait mode (1)

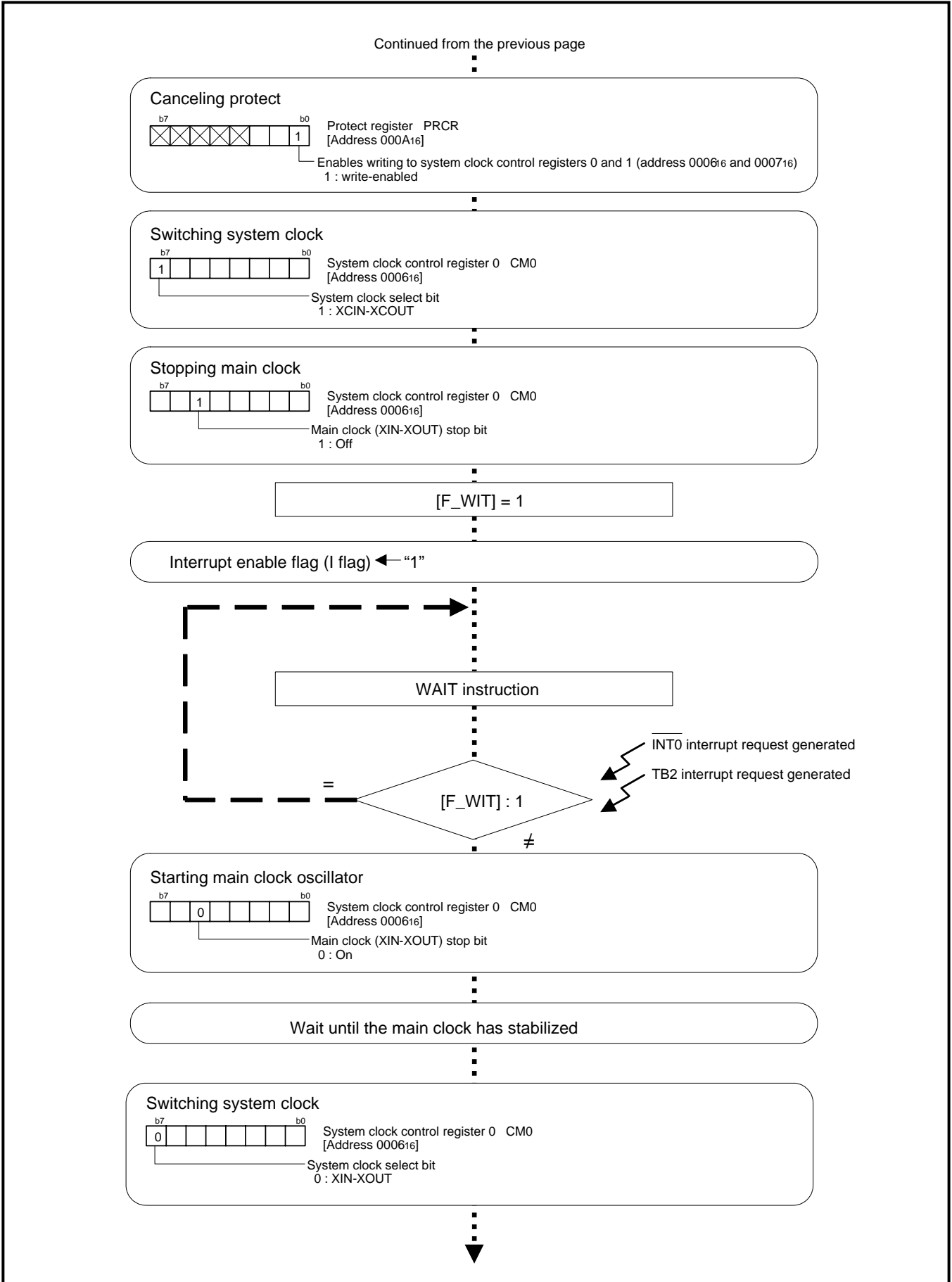


Figure 3. Set-up procedure of controlling power using wait mode(2)

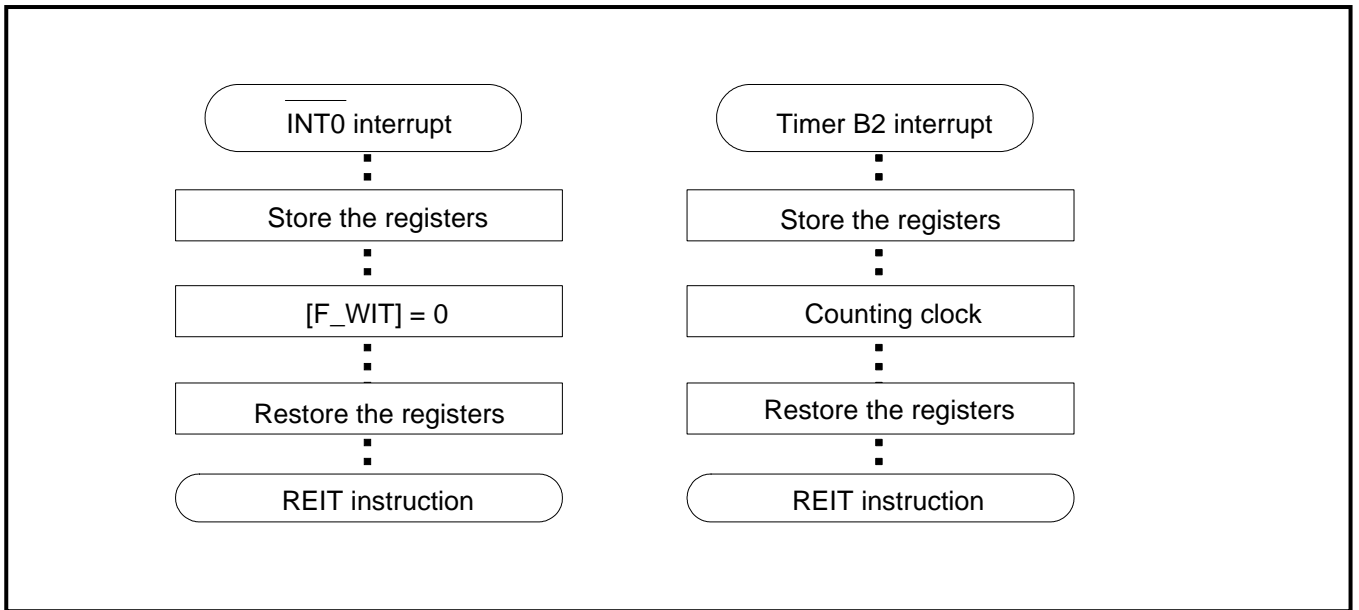


Figure 4. Set-up procedure of controlling power using wait mode (3)

5. The example of reference program

```

*****
;
;
; M16C/62P Program Collection
;
; FILE NAME : rjj05b0699_src.a30
; CPU       : M16C/62P Group
; FUNCTION  : Controlling Power Using Wait Mode
; HISTORY   : 2004.12.24 Ver 1.00
;
; Copyright(C)2004, Renesas Technology Corp.
; Copyright(C)2004, Renesas Solutions Corp.
; All rights reserved.
;
*****
;
*****
; Include
*****
;
; .LIST      off           ;Stops outputting lines to the assembler list file
; .INCLUDE   sfr62p.inc    ;Reads the file that defined SFR
; .LIST      on           ;Starts outputting lines to the assembler list file
;
;
*****
; Symbol definition
*****
;
;
RAM_TOP      .equ    00400h    ;Start address of RAM
RAM_END      .equ    013ffh    ;End address of RAM
ROM_TOP      .equ    0f4000h   ;Start address of ROM
VECT_TOP     .equ    0ffe00h   ;Start address of vect_top
FIXED_VECT_TOP .equ    0fffdch  ;Start address of fixed_vect_top
SB_BASE      .equ    00380h   ;Base address of sb
;
*****
; WORKRAM area definition
*****
;
; .section   work,data      ;Declares section name and section type
; .org      RAM_TOP        ;Declares start address
;
workram_top:
;
;
FLAG:        .blkb         1    ;
WACTH_CNT:   .blkb         1    ;Count
*****
;

```



```

;      Bit Symbol definition
;*****
F_WIT          .btequ          0,FLAG ; Wait mode judgment flag
;
;*****
;      Program area
;*****
;=====
;      Start up
;=====
;
;      .section program,code          ;Declares section name and section type
;      .org          ROM_TOP          ;Declares start address
;      .sb          SB_BASE          ;
;
START:
;      ldc          #RAM_END+1,isp ;Sets interrupt stack pointer
;      ldc          #SB_BASE,sb      ;Sets sb register
;
;      mov.b        #03h,prcr        ;Removes protect
;                                     ;Set processor mode registers 0 and 1
;      mov.w        #0800h,pm0       ;Single-chip mode
;                                     ;No expansion, No wait
;      mov.w        #2008h,cm0       ;Xcin-Xcout High
;                                     ;Xin-Xout High, Main clock is No divison
;      mov.b        #0,prcr          ;Protects all registers
;
;      ldintb       #VECT_TOP        ;Sets interrupt table register
;
;      mov.w        #0,r0              ;Clears WORKRAM area
;      mov.w        #((RAM_END+1)-RAM_TOP)/2,r3
;      mov.w        #RAM_TOP,a1
;      sstr.w
;
;=====
;      Main program
;=====
MAIN:
;      jsr          INIT
;
MAIN_A:
;      btst         ir_ta0ic          ;Wait Oscillation stability(100ms)
;      jnc          MAIN_A            ;
;      bclr         ir_ta0ic          ;
;      inc.b        r0I               ;
;      cmp.b        #100,r0I          ;
;      jnz          MAIN_A            ;
;      mov.b        #00h,r0I         ;Clear

```

```

;
mov.b      #00000001b,prcr ;Removes protect
mov.b      #10011000b,cm0 ;System clock control register 0
;
;      | |+-----;Xcin-Xcout(High)
;      | +-----;Xcin-Xcout generation function
;      +-----;Sub clock
;
mov.b      #10111000b,cm0 ;System clock control register 0
;
;      ||+-----;Xcin-Xcout(High)
;      | |+-----;Xcin-Xcout generation function
;      | +-----;Main clock stop
;      +-----;Sub clock
bset       F_WIT          ;Wait mode judgment flag
mov.b      #10000000b,tabsr ;Count start flag
;
;                               ;Timer A0 stop
mov.w      #500-1,ta0      ;Timer A0 register(16mhz:1ms)
mov.b      #00000000b,ta0ic ;Interrupt control register
;
;      +-----;Interrupt request bit (0:interrupt not requested)
fset       i              ;Set interrupt enable flag
;
MAIN_B:
;
jmp.b      MAIN_C          ;TN-16C-128A/JA(Japanese) countermeasure
;
;                               ;TN-16C-128A/EA(English) countermeasure
MAIN_C:
;
wait                               ;Wait mode
;
nop
nop
nop
nop
;
btst       F_WIT          ;Judge flag
jc         MAIN_B
mov.b      #10011000b,cm0 ;System clock control register 0
;
;      ||+-----;Xcin-Xcout(High)
;      | |+-----;Xcin-Xcout generation function
;      | +-----;Main clock start
;      +-----;Sub clock
;
mov.b      #10000001b,tabsr ;Count start flag
;
;                               ;Timer A0 start
MAIN_D:
;
btst       ir_ta0ic       ;Wait oscillation stability(1ms)
jnc       MAIN_D          ;

```

```

bclr      ir_ta0ic      ;
mov.b     #00011000b,cm0 ;System clock control register 0
;
;          | | | +-----;Xcin-Xcout(High)
;          | | +-----;Xcin-Xcout generation function
;          | +-----;Main clock start
;          +-----;Main clock
;
;
mov.b     #00000000b,prcr ;Protects all registers
jmp      MAIN_A
;
;
;=====
;      Initialize program
;=====
INIT:
mov.b     #00000001b,prcr ;Removes protect
mov.b     #00011000b,cm0 ;System clock control register 0
;
;          | +-----;Xcin-Xcout(High)
;          +-----;Xcin-Xcout generation function
mov.b     #00000000b,prcr ;Protects all registers
mov.b     #11000000b,tb2mr;Timer B2 mode register
;
;          ++-----;Count source select bit(fc32)
mov.w     #03ffh,tb2      ;Timer B2 register
mov.b     #10000000b,cpsrf ;Clock prescaler reset flag
mov.b     #00000001b,tb2ic ;Interrupt control register
;
;          |+++-----;Interrupt priority level select bit
;          |          ;(001:Level 1, interrupt disabled)
;          +-----;Interrupt request bit (0:interrupt not requested)
mov.b     #00000001b,int0ic ;Interrupt control register
;
;          |+++-----;Interrupt priority level select bit
;          |          ;(001:Level 1, interrupt disabled)
;          +-----;Interrupt request bit (0:interrupt not requested)
;
;
mov.b     #10000000b,ta0mr;Timer A0 mode register
;
;          ++-----;Count source select bit(f32)
mov.w     #500-1,ta0      ;Timer A0 register(16mhz:1ms)
mov.b     #00000000b,ta0ic ;Interrupt control register
;
;          |+++-----;Interrupt priority level select bit
;          |          ;(000:Level 0, interrupt disabled)
;          +-----;Interrupt request bit (0:interrupt not requested)
mov.b     #00000001b,tabsr ;Count start flag
INIT_END:
rts
;=====
;      Interrupt program
;=====
INT0_INT:

```

```

        pushm      r0,r1,r2,r3,a0,a1  ;Take shelter register
;
        bclr      F_WIT              ;Judgment flag clear
;
        popm      r0,r1,r2,r3,a0,a1  ;Comeback register
        reit
;
;=====
;      Interrupt program
;=====
TB2_INT:
        pushm      r0,r1,r2,r3,a0,a1  ;Take shelter register
;
        inc.b     WACTH_CNT          ;Count
;
        popm      r0,r1,r2,r3,a0,a1  ;Comeback register
        reit
;
;=====
;      Dummy interrupt processing program
;=====
DUMMY:
        reit
;
;*****
;      Setting of variable vector table
;*****
;
        .section vect,romdata
        .org      VECT_TOP + (4 * 4)
;
        .lword    DUMMY              ;INT3 interrupt vector
        .lword    DUMMY              ;TB5 interrupt vector
        .lword    DUMMY              ;TB4 interrupt vector
                                   ;UART1 bus collision detection interrupt vector
        .lword    DUMMY              ;TB3 interrupt vector
                                   ;UART0 bus collision detection interrupt vector
        .lword    DUMMY              ;SI/04/INT5 interrupt vector
        .lword    DUMMY              ;SI/03/INT4 interrupt vector
        .lword    DUMMY              ;UART2 bus collision detection interrupt vector
        .lword    DUMMY              ;DMA0 interrupt vector
        .lword    DUMMY              ;DMA1 interrupt vector
        .lword    DUMMY              ;KEY interrupt vector
        .lword    DUMMY              ;A-D interrupt vector
        .lword    DUMMY              ;UART2 transmit/NACK interrupt vector
        .lword    DUMMY              ;UART2 receive/ACK interrupt vector

```

```

.word          DUMMY          ;UART0 transmit/NACK interrupt vector
.word          DUMMY          ;UART0 receive/ACK interrupt vector
.word          DUMMY          ;UART1 transmit/NACK interrupt vector
.word          DUMMY          ;UART1 receive/ACK interrupt vector
.word          DUMMY          ;TA0 interrupt vector
.word          DUMMY          ;TA1 interrupt vector
.word          DUMMY          ;TA2 interrupt vector
.word          DUMMY          ;TA3 interrupt vector
.word          DUMMY          ;TA4 interrupt vector
.word          DUMMY          ;TB0 interrupt vector
.word          DUMMY          ;TB1 interrupt vector
.word          TB2_INT        ;TB2 interrupt vector
.word          INT0_INT       ;INT0 interrupt vector
.word          DUMMY          ;INT1 interrupt vector
.word          DUMMY          ;INT2 interrupt vector
;
;*****
;
;      Setting of fixed vector
;*****
;
;
;      .section f_vect,romdata
;      .org          FIXED_VECT_TOP
;
;      .word          DUMMY          ;Undefined instruction interrupt vector
;      .word          DUMMY          ;Overflow (INTO instruction) interrupt vector
;      .word          DUMMY          ;BRK instruction interrupt vector
;      .word          DUMMY          ;Address match interrupt vector
;      .word          DUMMY          ;Single-step interrupt vector
;      .word          DUMMY          ;Watchdog timer interrupt vector
;      .word          DUMMY          ;Oscillation stop and Re-oscillation detection interrupt
;      .word          DUMMY          ;vector
;      .word          DUMMY          ;Voltage down detection interrupt vector
;      .word          DUMMY          ;DBC interrupt vector
;      .word          DUMMY          ;NMI interrupt vector
;      .word          START        ;Sets start vector
;
;      .end

```

6. Referense

Hardware manual

M16C/62P group (M16C/62P,M16C/62PT) Hardware Manual Rev.2.30

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